



BAV199DWQ

### QUAD SURFACE MOUNT LOW LEAKAGE DIODE

### **Features**

- Surface Mount Package Ideally Suited for Automated Insertion
- Very Low Leakage Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

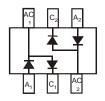
## **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.006 grams (Approximate)

### SOT363







Top View Internal Schematic

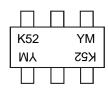
## **Ordering Information (Note 5)**

Part Number	Compliance	Case	Packaging
BAV199DWQ-7-F	Automotive	SOT363	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



K52 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

### Date Code Key

Year	2016	2017	20	18	2019	2020	2021	202	2 20	)23	2024	2025
Code	D	E	F	=	G	Н	1	J		K	L	М
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>R</sub> WM	85	V	
RMS Reverse Voltage	V <sub>R(RMS)</sub>	60	V	
Forward Continuous Current (Note 6) Single Diode Double Diode		I <sub>FM</sub>	160 140	mA
Repetitive Peak Forward Current (Note 6)	I <sub>FRM</sub>	500	mA	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I <sub>FSM</sub>	4.0 1.0 0.5	А

## **Thermal Characteristics**

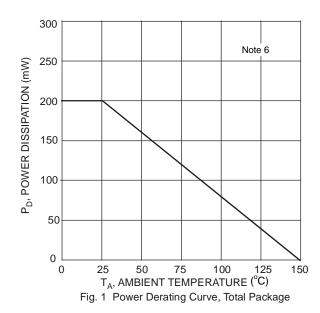
Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 6)	$P_{D}$	200	mW	
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	625	°C/W	
Operating and Storage Temperature Range	$T_J$ , $T_{STG}$	-65 to +150	°C	

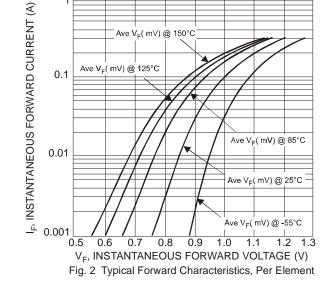
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	85	_	_	V	$I_R = 100 \mu A$
Forward Voltage	V <sub>F</sub>	_	_	0.90 1.0 1.1 1.25	٧	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Leakage Current (Note 7)	I <sub>R</sub>		_	5.0 80	nA	$V_R = 75V$ $V_R = 75V$ , $T_J = +150$ °C
Total Capacitance	C <sub>T</sub>	_	1.5	_	pF	$V_R = 0$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>RR</sub>		_	3.0	μS	$I_F = I_R = 10 \text{mA},$ $I_{RR} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes:

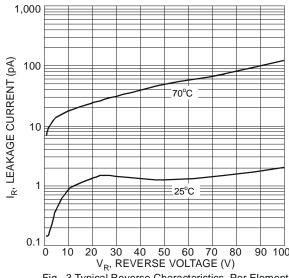
- 6. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.

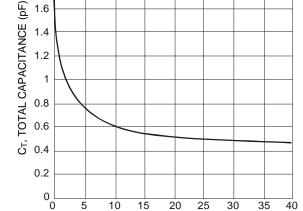




f =1MHz







V<sub>R</sub>, REVERSE VOLTAGE (V)

Fig. 4 Typical Total Capacitance

2

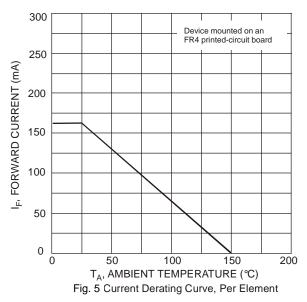
1.8

1.6

1.4

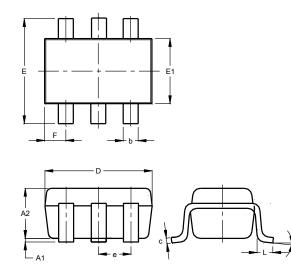
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# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

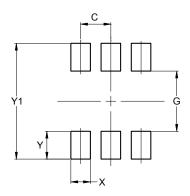


SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	1.00			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						



## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500

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